

Title (en)

LOW DENSITY POLISHING PAD

Title (de)

POLIERKISSEN MIT NIEDRIGER DICHTE

Title (fr)

TAMPON DE POLISSAGE À FAIBLE DENSITÉ

Publication

**EP 3027363 A1 20160608 (EN)**

Application

**EP 14747270 A 20140717**

Priority

- US 201313955398 A 20130731
- US 2014047065 W 20140717

Abstract (en)

[origin: US2015038066A1] Low density polishing pads and methods of fabricating low density polishing pads are described. In an example, a polishing pad for polishing a substrate includes a polishing body having a density of less than 0.5 g/cc and composed of a thermoset polyurethane material. A plurality of closed cell pores is dispersed in the thermoset polyurethane material.

IPC 8 full level

**B24B 37/24** (2012.01)

CPC (source: EP US)

**B24B 37/205** (2013.01 - US); **B24B 37/24** (2013.01 - EP US); **B24D 11/006** (2013.01 - US); **B24D 11/04** (2013.01 - US)

Citation (search report)

See references of WO 2015017138A1

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